HIDECK®

High Performance Dry Screed Overlay Boards

CELLECTA's range of HIDECK® high density floor elements are the ideal product for a multitude of flooring applications.

MIDECK® 18 increases the efficiency of an underfloor heating boards system due to its low thermal resistance and rapid heat transfer characteristics.

IMDECK® WF composite acoustic treatment will help a timber or concrete floor construction exceed the acoustic requirements of Part E of the Building Regulations.

Key features of **MDECK® 18**

- Very low thermal resistance (0.045m²/kW)
- High thermal conductivity (0.40W/mK)
- Low thermal expansion
- Only 18mm thick
- Doesn't contract or expand like chipboard when exposed to water
- High impact resistance
- Tongue & groove edge detail no screws required
- Quick and easy to install
- Accepts ceramic tiles

Additional features of HIDECK® WF

- High acoustic performance⁽²⁾: Airborne 50dB (inc CTR)⁽¹⁾ & Impact 57dB⁽¹⁾
- Only 28mm thick

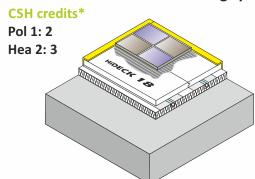
⁽¹⁾Typical PCT performance

	HiDECK ® 18 (Overlay board)	HiDECK® WF (Acoustic composite)
Thickness	18mm	28mm (18mm + 10 resilient layer)
Board size	600mm x 1200mm	600mm x 1200mm
Weight per board	15.55kg	16.70kg
Weight per m ²	21.60kg	23.20kg
Edge profile	Tongue & groove	Tongue & groove
Thermal resistance	0.045 m²/kW	N/A

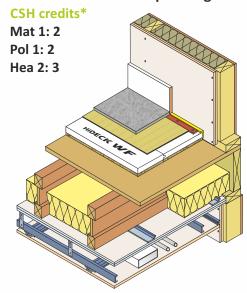


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Floors with under floor heating system



Timber floor separating floor



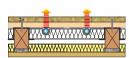
Thermal Resistance

MIDECK® floor elements enable boilers, ground water heat pumps and heat recovery systems to work at maximum efficiency and deliver comfortable, controllable heat to the occupant quicker than traditional floor finishes.

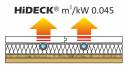
Thermal and acoustic applications



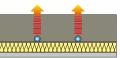
Acoustic Battens: m²/kW 0.237



Thermal applications



75mm Screed m²/kW 0.065



18mm Chipboard m²/kW 0.138









